

PBLS1504Y; PBLS1504V

15 V PNP BISS loadswitch

Rev. 02 — 25 November 2004

Product data sheet

1. Product profile

1.1 General description

Low V_{CEsat} PNP transistor and NPN resistor-equipped transistor in one package.

Table 1: Product overview

Type number	Package	
	Philips	JEITA
PBLS1504Y	SOT363	SC-88
PBLS1504V	SOT666	-

1.2 Features

- Low V_{CEsat} (BISS) and resistor-equipped transistor in one package
- Low 'threshold' voltage (< 1 V) compared to MOSFET
- Low drive power required
- Space-saving solution
- Reduction of component count.

1.3 Applications

- Supply line switches
- Battery charger switches
- High-side switches for LEDs, drivers and backlights
- Portable equipment.

1.4 Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
TR1; PNP; low V_{CEsat} transistor						
V_{CEO}	collector-emitter voltage	open base	-	-	-15	V
I_C	collector current (DC)		-	-	-500	mA
R_{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	-	300	500	$\text{m}\Omega$
TR2; NPN; resistor-equipped transistor						
V_{CEO}	collector-emitter voltage	open base	-	-	50	V

PHILIPS

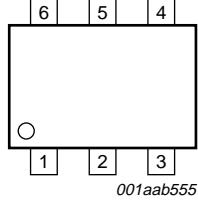
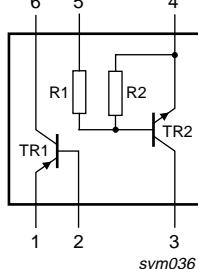
Table 2: Quick reference data ...*continued*

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_o	output current (DC)		-	-	100	mA
R1	bias resistor 1 (input)		15.4	22	28.6	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	

2. Pinning information

Table 3: Discrete pinning

Pin	Description	Simplified outline	Symbol
1	emitter TR1		
2	base TR1		
3	output (collector) TR2		
4	GND (emitter) TR2		
5	input (base) TR2		
6	collector TR1		

3. Ordering information

Table 4: Ordering information

Type number	Package		Version
	Name	Description	
PBLS1504Y	SC-88	plastic surface mounted package; 6 leads	SOT363
PBLS1504V	-	plastic surface mounted package; 6 leads	SOT666

4. Marking

Table 5: Marking codes

Type number	Marking code [1]
PBLS1504Y	*C4
PBLS1504V	C4

[1] * = -: made in Hong Kong.

* = p: made in Hong Kong.

* = t: made in Malaysia.

* = W: made in China.

5. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Transistor TR1: PNP					
V_{CBO}	collector-base voltage	open emitter	-	-15	V
V_{CEO}	collector-emitter voltage	open base	-	-15	V
V_{EBO}	emitter-base voltage	open collector	-	-6	V
I_C	collector current (DC)		-	-500	mA
I_{CM}	peak collector current	$t_p \leq 1 \text{ ms}; \delta \leq 0.02$	-	-1	A
I_B	base current (DC)		-	-50	mA
I_{BM}	peak base current	$t_p \leq 1 \text{ ms}; \delta \leq 0.02$	-	-100	mA
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25 \text{ }^{\circ}\text{C}$	[1]	-	200 mW
Transistor TR2: NPN					
V_{CBO}	collector-base voltage	open emitter	-	50	V
V_{CEO}	collector-emitter voltage	open base	-	50	V
V_{EBO}	emitter-base voltage	open collector	-	10	V
V_I	input voltage		-		
	positive		-	+40	V
	negative		-	-10	V
I_O	output current (DC)		-	100	mA
I_{CM}	peak collector current		-	100	mA
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25 \text{ }^{\circ}\text{C}$	[1]	-	200 mW
Per device					
P_{tot}	total power dissipation	$T_{\text{amb}} \leq 25 \text{ }^{\circ}\text{C}$	-	300	mW
T_{stg}	storage temperature		-65	+150	$^{\circ}\text{C}$
T_j	junction temperature		-	150	$^{\circ}\text{C}$
T_{amb}	ambient temperature		-65	+150	$^{\circ}\text{C}$

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7: Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per device						
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air				
	SOT363	[1]	-	-	416	K/W
	SOT666	[1][2]	-	-	416	K/W

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

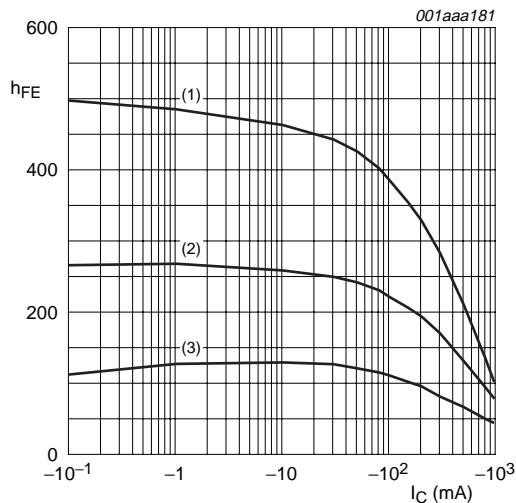
[2] Reflow soldering is the only recommended soldering method.

7. Characteristics

Table 8: Characteristics $T_{amb} = 25^\circ\text{C}$ unless otherwise specified.

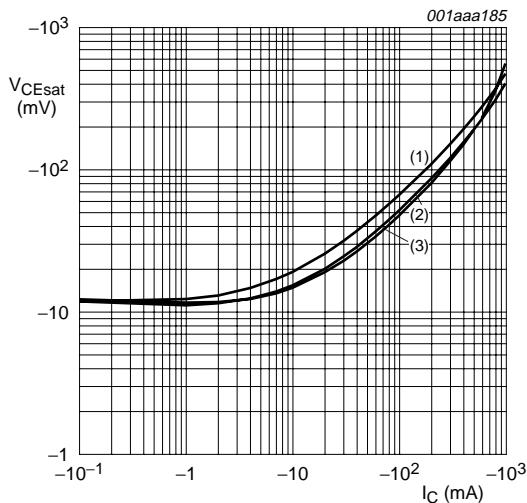
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
Transistor TR1: PNP							
I_{CBO}	collector-base cut-off current	$V_{CB} = -15 \text{ V}; I_E = 0 \text{ A}$	-	-	-100	nA	
		$V_{CB} = -15 \text{ V}; I_E = 0 \text{ A}; T_j = 150^\circ\text{C}$	-	-	-50	μA	
I_{CES}	collector-emitter cut-off current	$V_{CE} = -15 \text{ V}; V_{BE} = 0 \text{ V}$	-	-	-100	nA	
I_{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	-	-	-100	nA	
h_{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_C = -10 \text{ mA}$	200	-	-		
		$V_{CE} = -2 \text{ V}; I_C = -100 \text{ mA}$	[1] 150	-	-		
		$V_{CE} = -2 \text{ V}; I_C = -500 \text{ mA}$	[1] 90	-	-		
V_{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -0.5 \text{ mA}$	-	-	-25	mV	
		$I_C = -200 \text{ mA}; I_B = -10 \text{ mA}$	-	-	-150	mV	
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	[1]	-	-250	mV	
R_{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	[1]	-	300	500	$\text{m}\Omega$
V_{BEsat}	base-emitter saturation voltage	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	[1]	-	-	-1.1	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_C = -100 \text{ mA}$	[1]	-	-	-0.9	V
f_T	transition frequency	$V_{CE} = -5 \text{ V}; I_C = -100 \text{ mA}; f = 100 \text{ MHz}$	100	280	-	MHz	
C_c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	10	pF	
Transistor TR2: NPN							
I_{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA	
I_{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$	-	-	1	μA	
		$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}; T_j = 150^\circ\text{C}$	-	-	50	μA	
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}$	-	-	180	μA	
h_{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_C = 5 \text{ mA}$	60	-	-		
V_{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	-	-	150	mV	
$V_{I(off)}$	off-state input voltage	$V_{CE} = 5 \text{ V}; I_C = 100 \mu\text{A}$	-	1.1	0.8	V	
$V_{I(on)}$	on-state input voltage	$V_{CE} = 0.3 \text{ V}; I_C = 5 \text{ mA}$	2.5	1.7	-	V	
$R1$	bias resistor 1 (input)		15.4	22	28.6	k Ω	
$R2/R1$	bias resistor ratio		0.8	1	1.2		
C_c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	2.5	pF	

[1] Pulse test: $t_p \leq 300 \mu\text{s}; \delta \leq 0.02$.



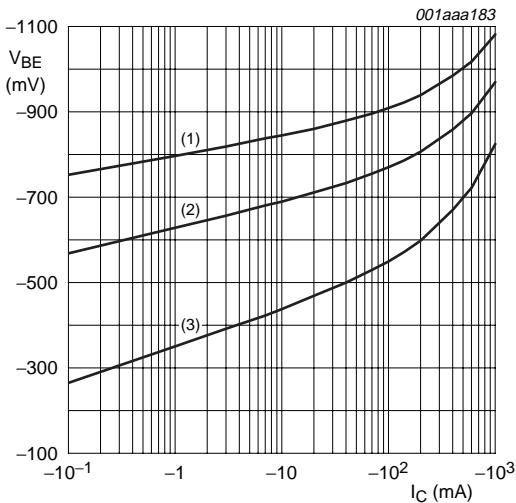
- $V_{CE} = -2\text{ V}$.
(1) $T_{amb} = 150\text{ }^{\circ}\text{C}$.
(2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
(3) $T_{amb} = -55\text{ }^{\circ}\text{C}$.

Fig 1. TR1(PNP): DC current gain as a function of collector current; typical values.



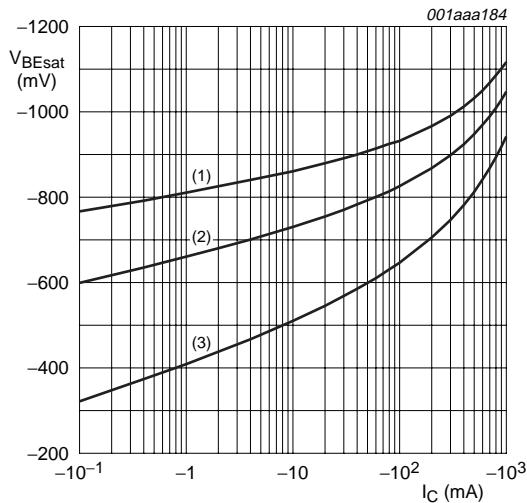
- $I_C/I_B = 20$.
(1) $T_{amb} = 150\text{ }^{\circ}\text{C}$.
(2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
(3) $T_{amb} = -55\text{ }^{\circ}\text{C}$.

Fig 2. TR1(PNP): Collector-emitter saturation voltage as a function of collector current; typical values.



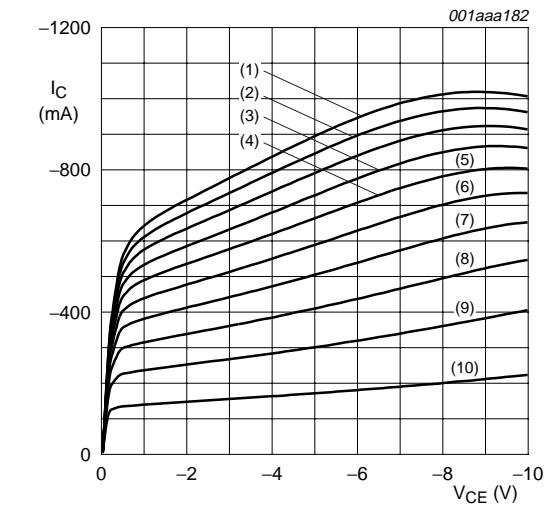
- $V_{CE} = -2\text{ V}$.
(1) $T_{amb} = -55\text{ }^{\circ}\text{C}$.
(2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
(3) $T_{amb} = 150\text{ }^{\circ}\text{C}$.

Fig 3. TR1(PNP): Base-emitter voltage as a function of collector current; typical values.



- $I_C/I_B = 20$.
(1) $T_{amb} = 150\text{ }^{\circ}\text{C}$.
(2) $T_{amb} = 25\text{ }^{\circ}\text{C}$.
(3) $T_{amb} = -55\text{ }^{\circ}\text{C}$.

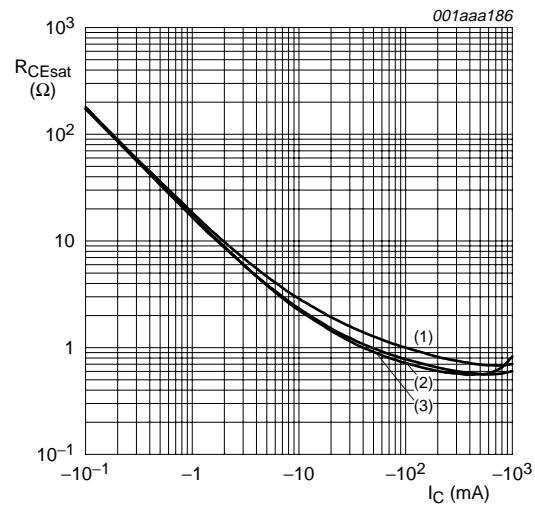
Fig 4. TR1(PNP): Base-emitter saturation voltage as a function of collector current; typical values.



$T_{amb} = 25^\circ\text{C}$.

- (1) $I_B = -7.0$ mA.
- (2) $I_B = -6.3$ mA.
- (3) $I_B = -5.6$ mA.
- (4) $I_B = -4.9$ mA.
- (5) $I_B = -4.2$ mA.
- (6) $I_B = -3.5$ mA.
- (7) $I_B = -2.8$ mA.
- (8) $I_B = -2.1$ mA.
- (9) $I_B = -1.4$ mA.
- (10) $I_B = -0.7$ mA.

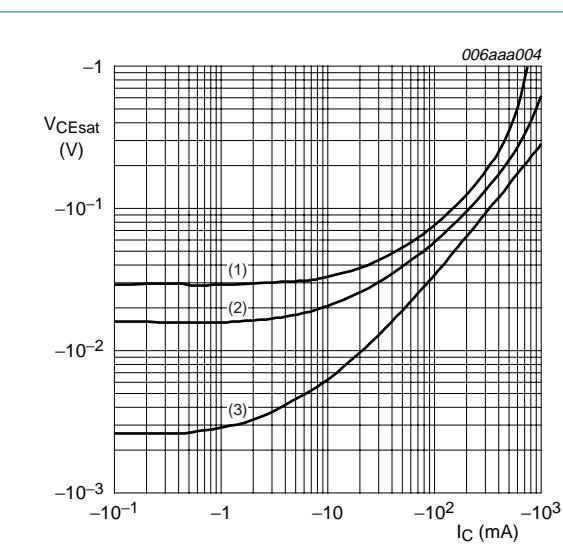
Fig 5. TR1(PNP): Collector current as a function of collector-emitter voltage; typical values.



$I_C/I_B = 20$.

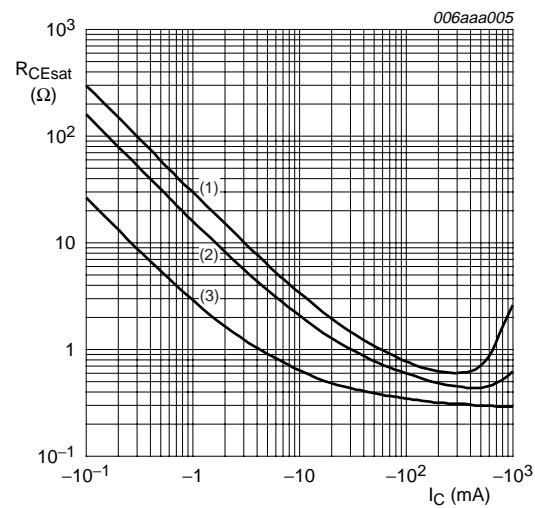
- (1) $T_{amb} = -55^\circ\text{C}$.
- (2) $T_{amb} = 25^\circ\text{C}$.
- (3) $T_{amb} = 150^\circ\text{C}$.

Fig 6. TR1(PNP): Equivalent on-resistance as a function of collector current; typical values.



$T_{amb} = 25^\circ\text{C}.$
(1) $I_C/I_B = 100.$
(2) $I_C/I_B = 50.$
(3) $I_C/I_B = 10.$

Fig 7. TR1(PNP): Collector-emitter saturation voltage as a function of collector current; typical values.



$T_{amb} = 25^\circ\text{C}.$
(1) $I_C/I_B = 100.$
(2) $I_C/I_B = 50.$
(3) $I_C/I_B = 10.$

Fig 8. TR1(PNP): Equivalent-on resistance as a function of collector current; typical values.

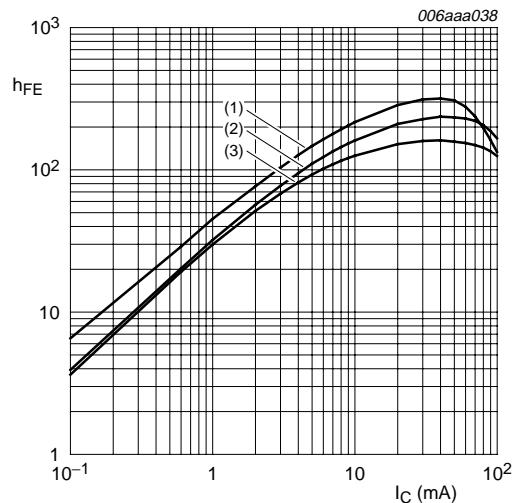


Fig 9. TR2(NPN): DC current gain as a function of collector current; typical values.

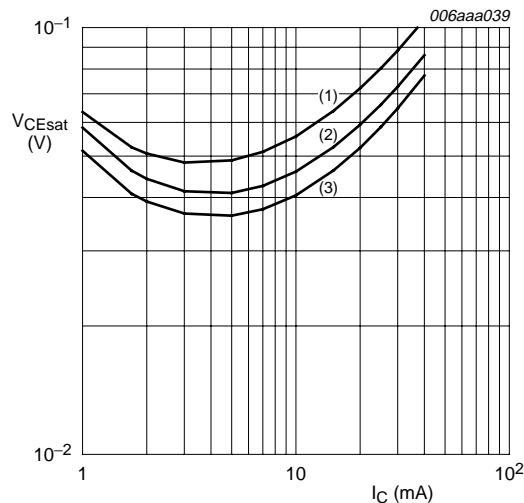


Fig 10. TR2(NPN): Collector-emitter saturation voltage as a function of collector current; typical values.

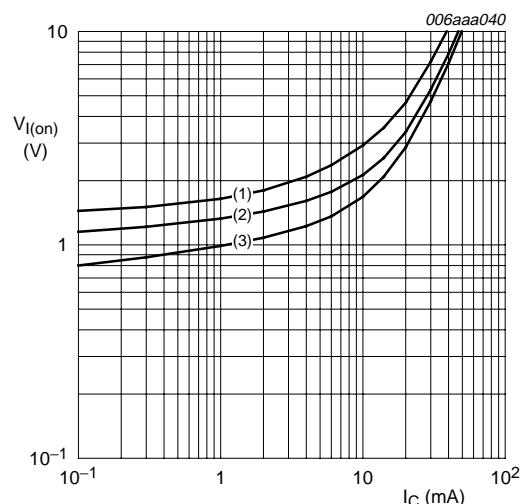


Fig 11. TR2(NPN): On-state input voltage as a function of collector current; typical values.

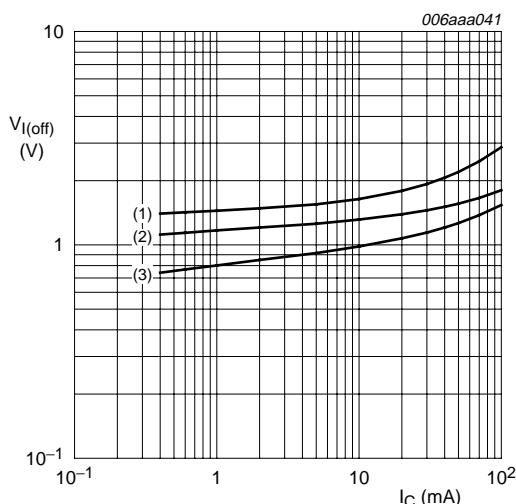
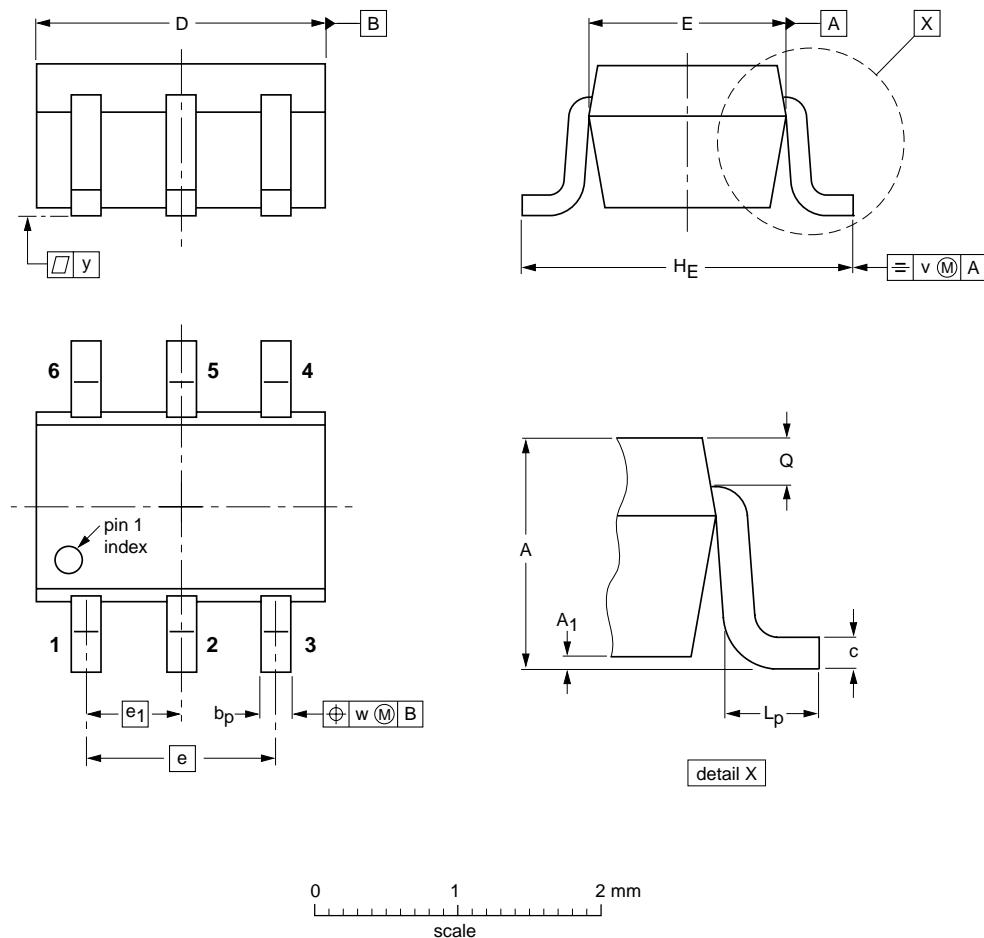


Fig 12. TR2(NPN): Off-state input voltage as a function of collector current; typical values.

8. Package outline

Plastic surface mounted package; 6 leads

SOT363



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	b _p	c	D	E	e	e ₁	H _E	L _p	Q	v	w	y
mm	1.1 0.8	0.1	0.30 0.20	0.25 0.10	2.2 1.8	1.35 1.15	1.3	0.65	2.2 2.0	0.45 0.15	0.25 0.15	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT363			SC-88			-97-02-28- 04-11-08

Fig 13. Package outline SOT363 (SC-88).

Plastic surface mounted package; 6 leads

SOT666

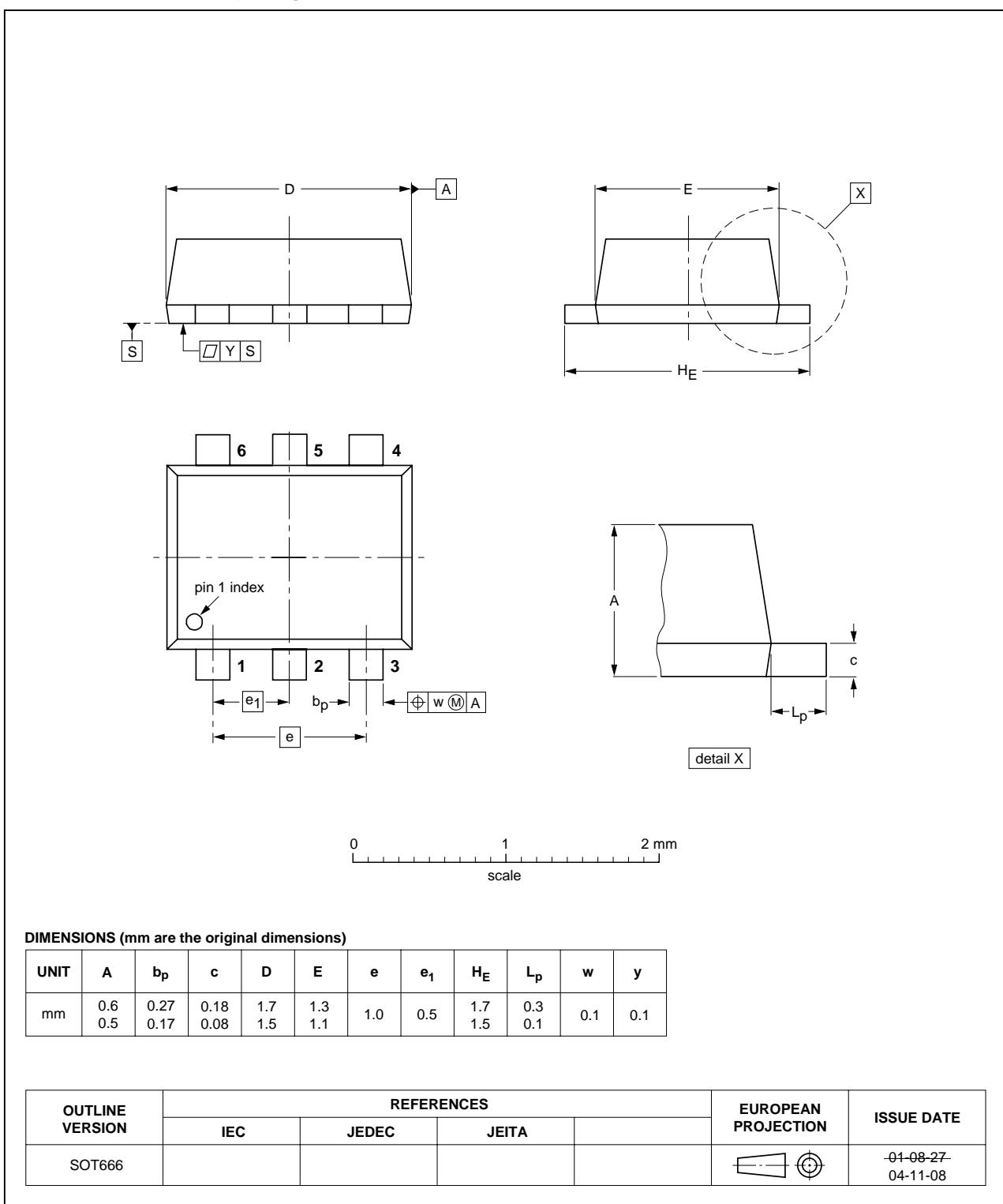


Fig 14. Package outline SOT666.

9. Packing information

Table 9: Packing methodsThe indicated -xxx are the last three digits of the 12NC ordering code.^[1]

Type number	Package	Description	Packing quantity		
			3000	4000	10000
PBLS1504Y	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2] -115	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3] -125	-	-165
PBLS1504V	SOT666	4 mm pitch, 8 mm tape and reel	-	-115	-

[1] For further information and the availability of packing methods, see [Section 14](#).

[2] T1: normal taping.

[3] T2: reverse taping.

10. Revision history

Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
PBLS1504Y_PBLS1504V_2	20041125	Product data sheet	-	9397 750 13436	PBLS1504V_1
Modifications:		<ul style="list-style-type: none">The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors.Type number PBLS1504Y added			
PBLS1504V_1	20031107	Product specification	-	9397 750 12188	-

11. Data sheet status

Level	Data sheet status [1]	Product status [2][3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

12. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

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For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com



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